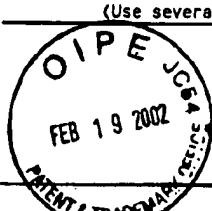


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Form PTO-1449	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. 728-163	SERIAL NO. 09/502,729
INFORMATION DISCLOSURE STATEMENT BY APPLICANT			
(Use several sheets if necessary)			
		APPLICANT Cohen, et al.	
		FILING DATE February 11, 2000	GROUP Art Unit 2814

U.S. PATENT DOCUMENT

EXAMINER INITIALS		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
WSL		5 8 6 1 6 5 1	01/19/99	Brasen, et al.				
WSL		5 5 2 1 1 2 7	05/28/96	Hori				

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
WSL		2 3 3 4 8 1 8	01/09/99	United Kingdom				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

		Conference Record of the 1988 IEEE International Symposium on Electrical Insulation, Cambridge USA, 5-8 June 1988, Gerstenberg, On structure and properties of plasma polymerized organo-silicon films, pages 141-144.	

EXAMINER	DATE CONSIDERED
	4/9/04

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.